



# 如何打造强大、智能、易于使用的HMI应用

CapSense® 电容式感应 与 MagSense™ 电感式感应

Harris Chan 高级现场应用工程师



# 日程

- 赛普拉斯公司及创新技术简介
- CapSense 与 MagSense 的对比
- 手把手实验: MagSense 电感式感应
- PSoC<sup>®</sup> MCU 发展路线图
- 入门参考资料

# Cypress' Industry-Leading Portfolio of Embedded Solutions

- **Wireless radio standards and combinations**

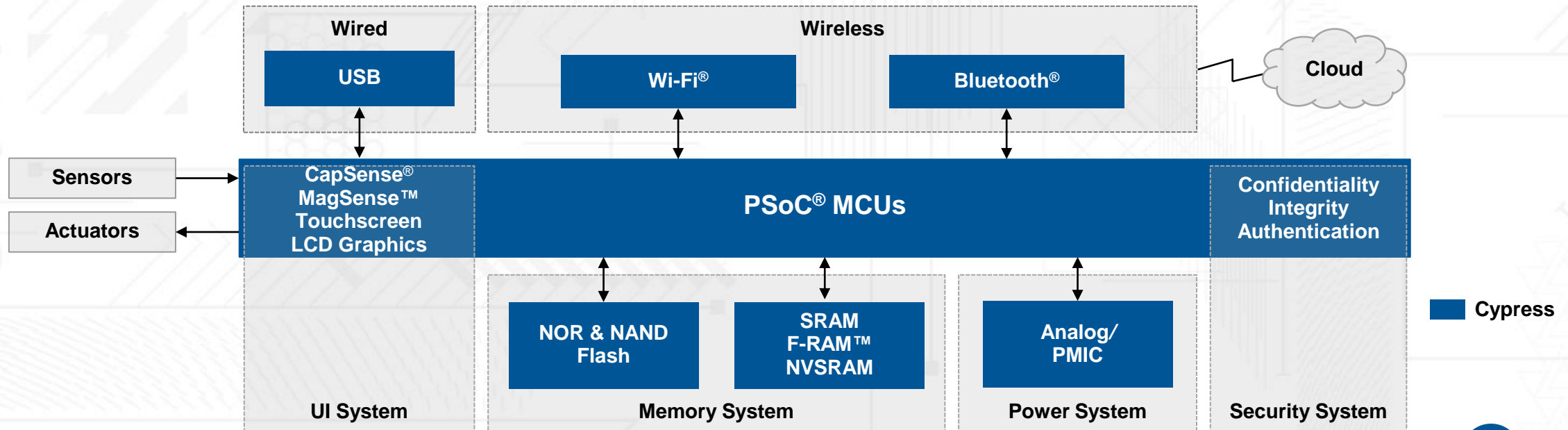
- Wi-Fi (802.11ac, 802.11bgn), Bluetooth (BR, EDR, BLE)
- Advanced coexistence algorithms for multi-radio (Wi-Fi + Bluetooth) platforms

- **Broad portfolio of Arm®-based MCUs**

- PSoC 4: Arm Cortex® M0 and M0+ devices ideal for HMI, sensor hubs, and other mixed-signal subsystems
- PSoC 6: Most-flexible, lowest-power, dual-core Arm Cortex-M4 and M0+ MCU—purpose-built for the IoT

- **Robust development tools and ecosystem partners**

- WICED® IoT platform provides turnkey wireless connectivity
- [PSoC Creator™](#) IDE speeds system configuration and design
- ModusToolbox™ Software Suite unifies MCU and wireless development environments





# Cypress' Innovation

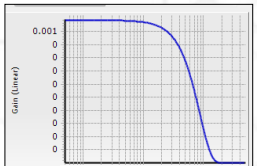
Cypress MCUs have been at the heart of industrial, consumer and automotive revolutions, offering game changing technologies and altering the way products evolve.



Wireless technologies built for the IoT. Secure, design-ready products



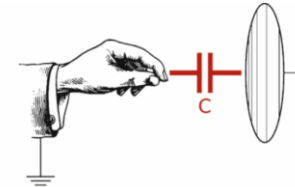
Hardware-based TEE, root-of-trust isolation, and secure data storage



Programmable Analog Blocks let you interface with nearly any sensor



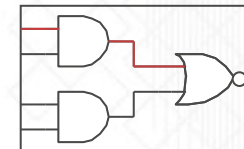
Ultra low power technologies enable industry-leading power consumption



CapSense solutions. Elegant, reliable, flexible and easy-to-use



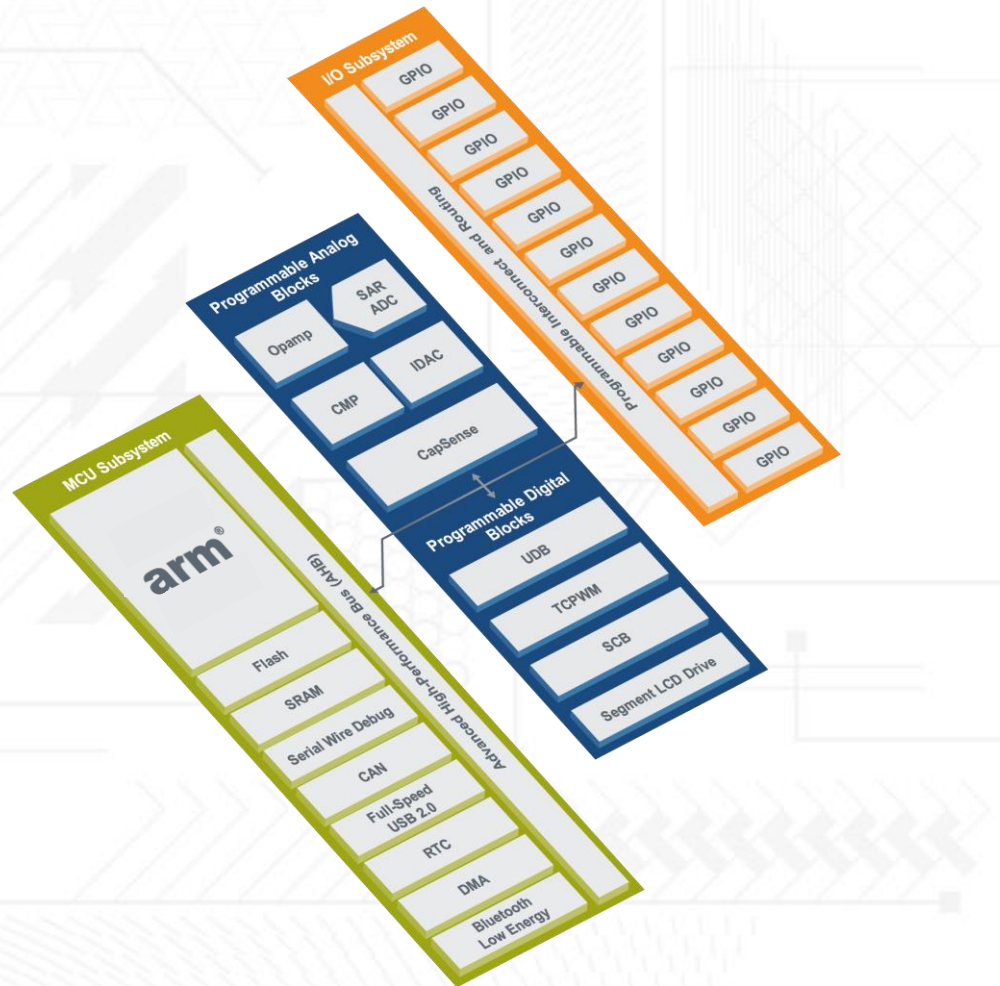
MagSense enables integrated contactless metal detection



Integrated array of small, fast, low-power programmable digital blocks

# PSoC : Your Problem Solver on Chip

Ultimate Mixed-Signal Flexibility



- **CapSense / MagSense**
  - Industry-leading capacitive and inductive sensing solutions
  - Touch, metal detection, proximity sensing and liquid-sensing applications
- **Programmable Analog Blocks**
  - Customize analog front end to interface to analog sensors
  - Comprised of ADC, DAC, opamps and comparators
- **Programmable Digital Blocks**
  - Configurable SCB and TCPWM blocks for digital peripherals
  - Programmable UDB blocks for digital glue logic
- **Wired and Wireless Connectivity**
  - Wired connectivity interface such as CAN and USB
  - Wireless connectivity such as Bluetooth Low Energy
- **Security**
  - Implements cryptographic algorithms including ECC and AES with an integrated hardware coprocessor
  - Provides secure, internal storage for firmware, applications, and secure assets such as cryptographic keys



Make It Smarter



Make It Connected



Make It Easy to Use



Make It Secure

# Capacitive and Inductive Sensing

## Enhancing User Interfaces

Cypress has changed the face of industrial design in consumer electronics, cars, and white goods, with its industry-leading CapSense and MagSense solutions. CapSense and MagSense solutions provide robust, intelligent, and easy-to-use sensing functionality to your design.

Touch Buttons: 2003



LG Chocolate  
(First Generation)

Cypress's CapSense research and development begins with buttons and sliders

Liquid Tolerance: 2008



Whirlpool Dishwasher  
(Second Generation)

CapSense algorithms offer Liquid Tolerance, Proximity Sensing and improved noise immunity

SmartSense: 2010



HP TouchSmart Printer  
(Third Generation)

SmartSense™ Auto-tuning revolutionizes CapSense design by removing manual tuning

1B Units Shipped: 2013



Samsung Galaxy Note 3  
(Third Generation)

One billionth CapSense controller shipped with stylus-activated buttons

PSoC 4 S-Series: 2016



PSoC 4 S-Series  
(Fourth Generation)

Cypress introduces its fourth-generation CapSense solution that offers superior touch-sensing performance with low power consumption

PSoC 4700 Family: 2018



PSoC 4700 Family  
(Sense AnyThing)

Cypress introduces its MagSense inductive sensing solution that offers superior metal detection performance with low power consumption

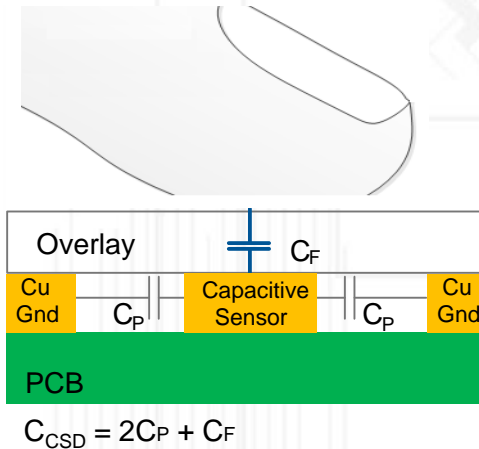


# Senzei™ Capacitive and Inductive Sensing

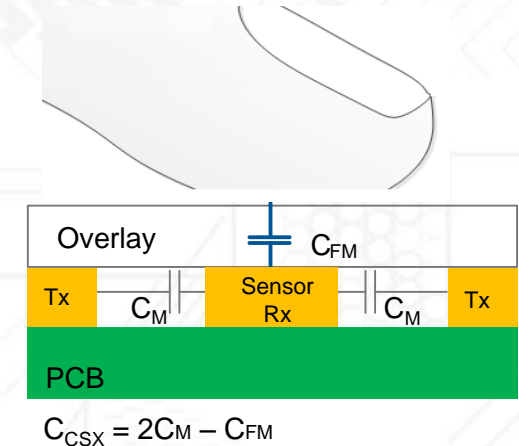
## Enhancing User Interfaces

- Senzei suite of sensing solutions
  - CapSense is the industry's leading self- and mutual-capacitive sensing solution for touch buttons and sliders, proximity detection, and liquid-level sensing
  - MagSense senses minute deflections or movements of metal, enabling sleek and futuristic user interfaces with metallic overlays
  - MagSense and CapSense can co-exist, even as one sensor, and provides a fool-proof solution that can not only detect any kind of object but also rejects false touches caused due to stress, wear and tear, or environmental changes

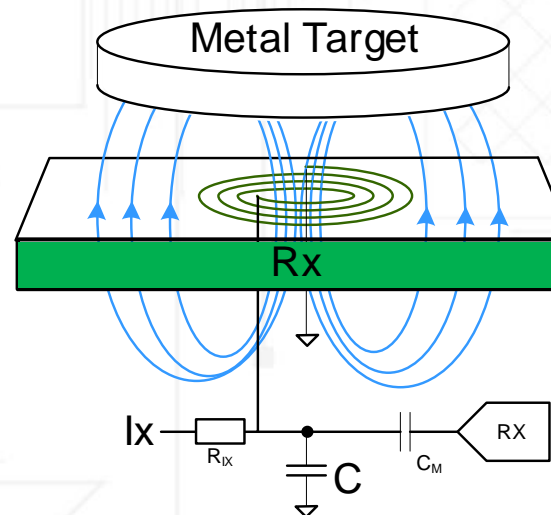
### Self-Capacitive Sensing



### Mutual-Capacitive Sensing



### Inductive Sensing



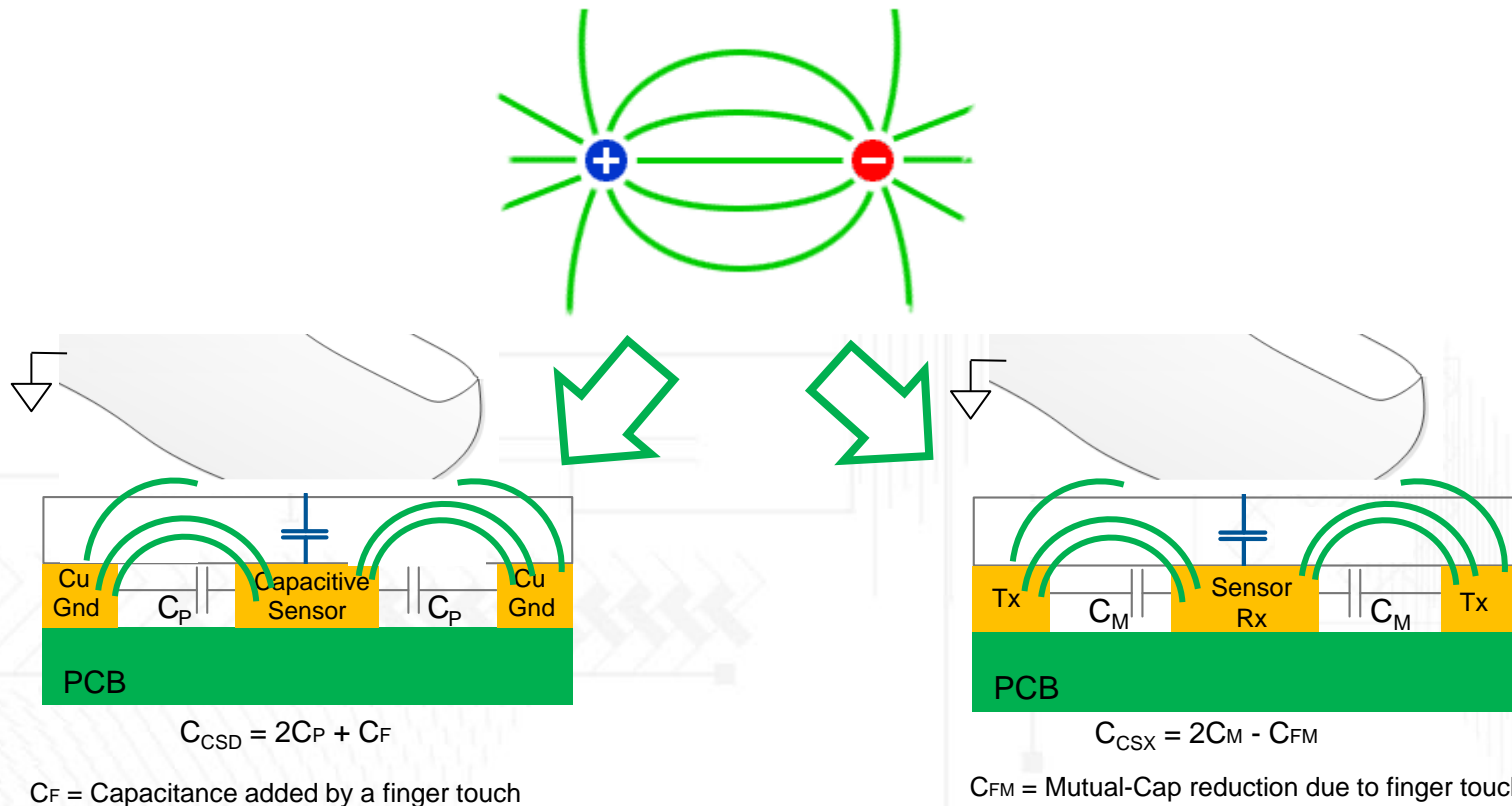
# CapSense Capacitive Sensing vs. MagSense Inductive Sensing





# CapSense Capacitive-Sensing

## Source: Electric Field Lines Between two voltage potentials



# CapSense Capacitive-Sensing

## Self Capacitive Sensing (CapSense CSD)

- Self capacitive sensing occurs when one node of the capacitor is sensed.
- The second node of the capacitor is at a fixed potential (usually ground).

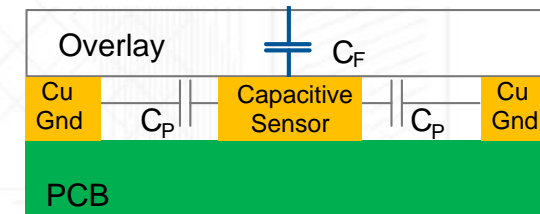
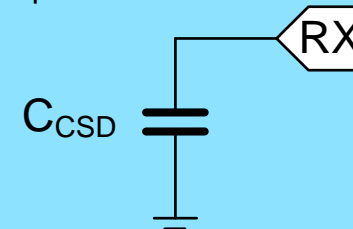
## CapSense CSD operation

- The self-capacitance sensor is formed between the sensor electrode and neighboring ground lines ( $C_P$ ).
- The total capacitance **without** a touch:  $C_{CSD} = 2C_P$
- The total capacitance **with** a touch:  $C_{CSD} = 2C_P + C_F$
- $C_F$  is the capacitance between the sensor and the grounded finger and **increases** the capacitance with a touch.

- **Note:** The finger appears to be *grounded* because of the large capacitance between the human body and earth.

## Self Capacitance Sensing (CSD)

We have access to only one node of the capacitor.



$$C_{CSD} = 2C_P + C_F$$

$C_F$  = Capacitance added by a finger touch

# CapSense Capacitive-Sensing

## ▪ Mutual Capacitive Sensing (CapSense CSX)

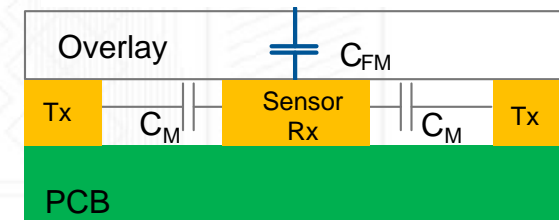
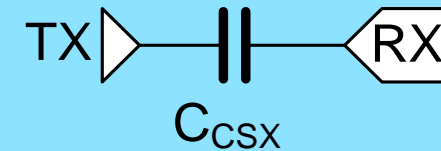
- Mutual capacitive sensing occurs when there is access to **both** nodes of the capacitor.
- A transmit (TX) signal is driven onto one node and received at the other.
- A change in capacitance is detected as a change in signal at the receiver (RX).

## ▪ CapSense CSX operation

- The mutual capacitance sensor is formed between the sensor RX electrode and the sensor TX electrodes ( $C_M$ ).
- The total capacitance **without** a touch:  $C_{CSD} = 2C_M$
- The total capacitance **with** a touch:  $C_{CSD} = 2C_M - C_F$
- $C_F$  is the capacitance between the sensor and the grounded finger and **decreases** the capacitance with a touch because it steals TX-RX field lines reducing  $C_M$ .
- **Note:** Mutual capacitance **decreases** with a touch while self-capacitance **increases** with a touch.

## Mutual Capacitance Sensing (CSX)

We have access to **both** nodes of the capacitor.



$$C_{CSX} = 2C_M - C_{FM}$$

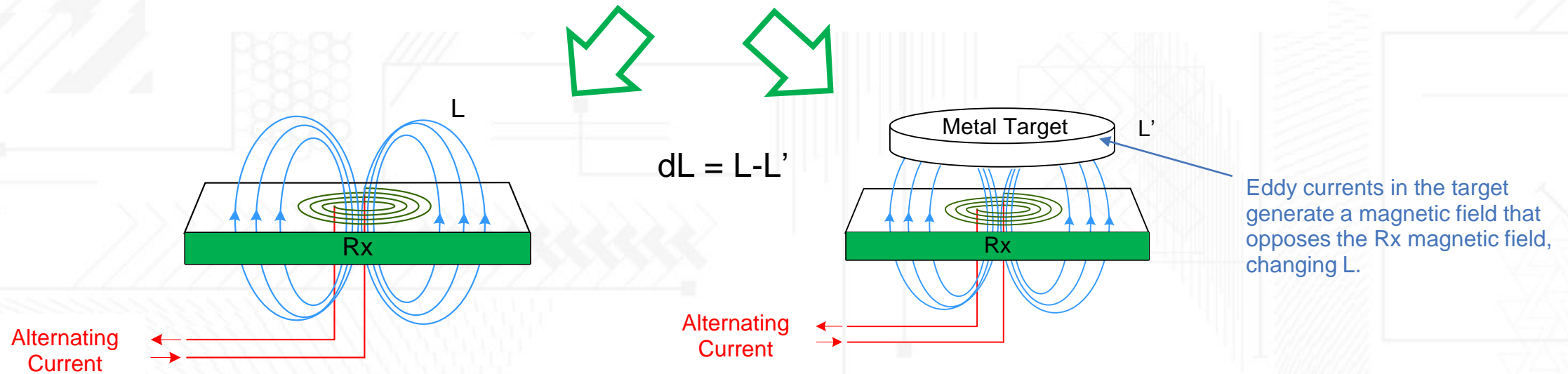
$C_{FM}$  = Mutual-Cap reduction due to finger touch



# MagSense Inductive-Sensing

- Driving an AC signal into an Inductive Coil creates a magnetic field
- Moving a metal target close to the field induces eddy currents in the target, changing the field.

## Source: Magnetic Field Lines



# MagSense Inductive-Sensing

## ■ Inductive-sensing (MagSense)

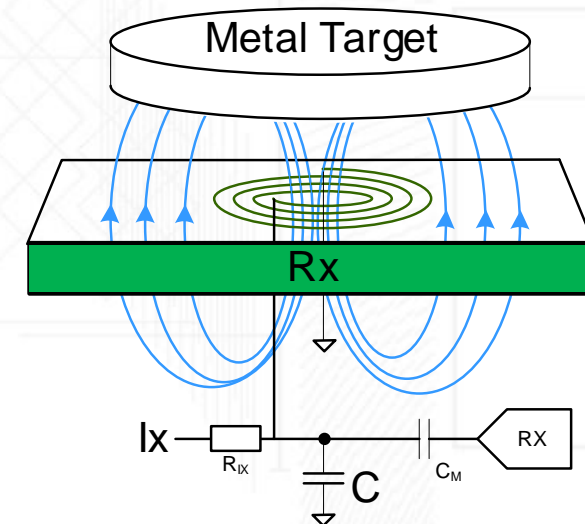
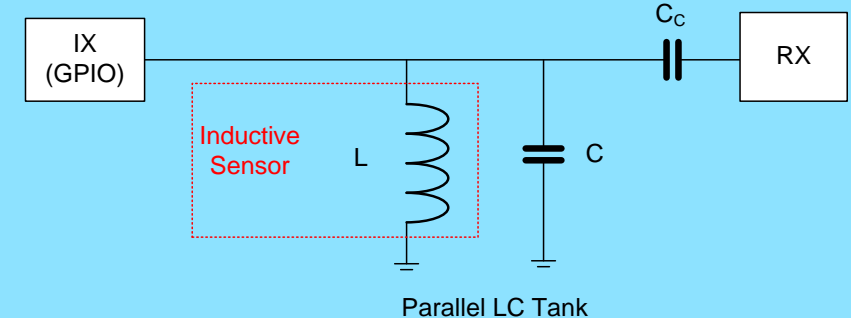
- The sensor forms a parallel LC tank that is excited at its resonant frequency and the resulting signal is coupled into the RX through  $C_C$ .
- A change in  $L$  causes an amplitude change in the LC tank signal.

## ■ MagSense ISX operation

- The parallel resonant tank formed by the sensor  $L$  and a discrete  $C$  produces a sine wave when excited by  $I_X$ .
- The magnetic field lines from the inductive sensor induces **eddy currents** in the metal target that oppose the sensor magnetic field lines, reducing the effective inductance ( $L$ ) of the sensor.
- This reduction in  $L$  manifests itself as a reduction in the **amplitude** of the sine wave produced by the LC tank.
- **Note:** Inductive-sensing detects a change in **magnetic field** while capacitive-sensing detects a change in **electric field**.

## Inductive Sensing (ISX)

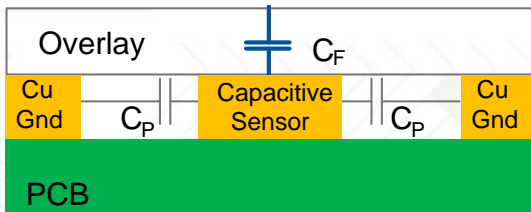
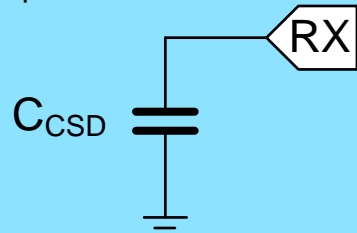
The sensor forms a parallel LC tank that is excited by a signal ( $I_X$ ). The tank signal is then AC coupled into the RX.



# CapSense and MagSense Summary

## Self Capacitance Sensing (CSD)

We have access to only one node of the capacitor.

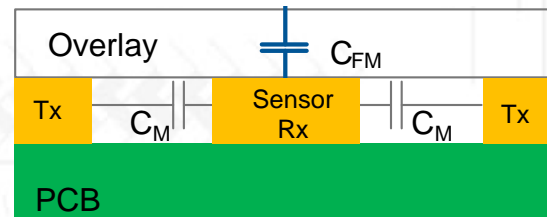
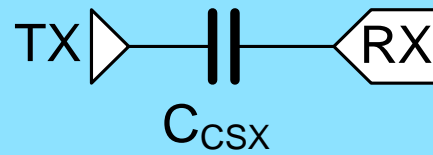


$$C_{CSD} = 2C_P + C_F$$

$C_F$  = Capacitance added by a finger touch

## Mutual Capacitance Sensing (CSX)

We have access to both nodes of the capacitor.

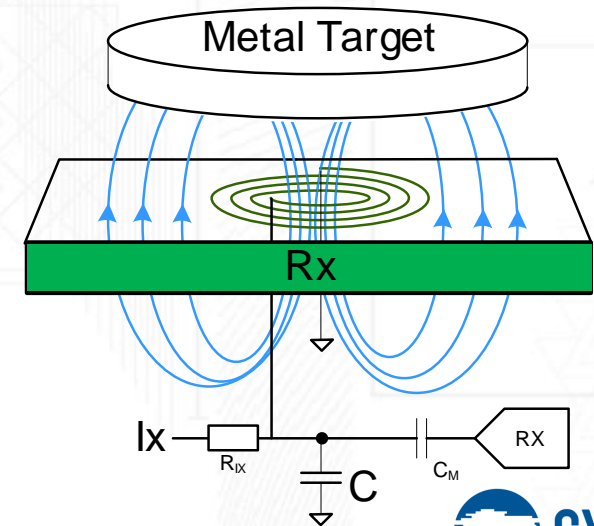
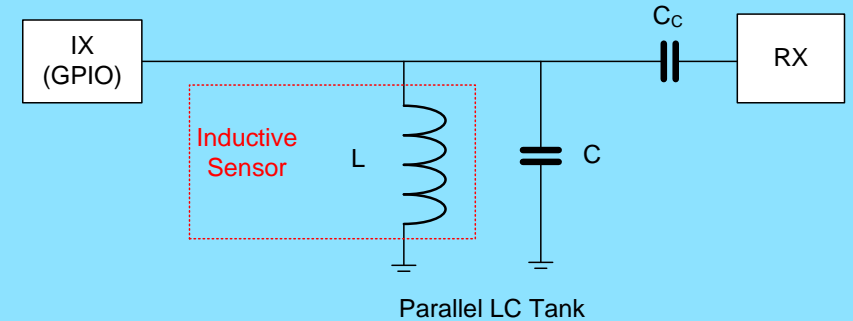


$$C_{CSX} = 2C_M - C_{FM}$$

$C_{FM}$  = Mutual-Cap reduction due to finger touch

## Inductive Sensing (ISX)

The sensor forms a parallel LC tank that is excited by a signal (IX). The tank signal is then AC coupled into the RX.





# CapSense Use Cases



CapSense Buttons



CapSense Slider



Capacitive Trackpad



Proximity Detection



Capacitive Liquid Level Sense



Specific Absorption Rate



Capacitive Force sensing



Absolute Capacitance sensing

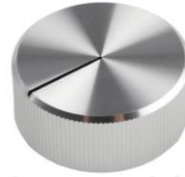
# MagSense Use Cases



MagSense Metal Buttons



MagSense Metal Proximity



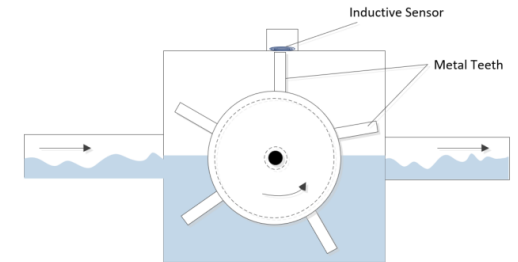
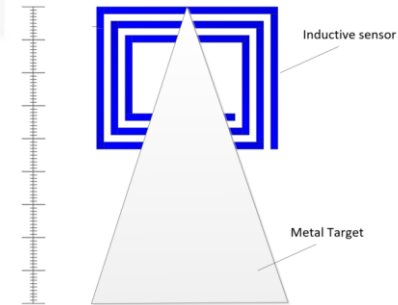
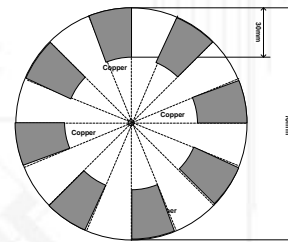
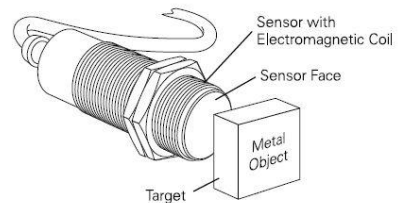
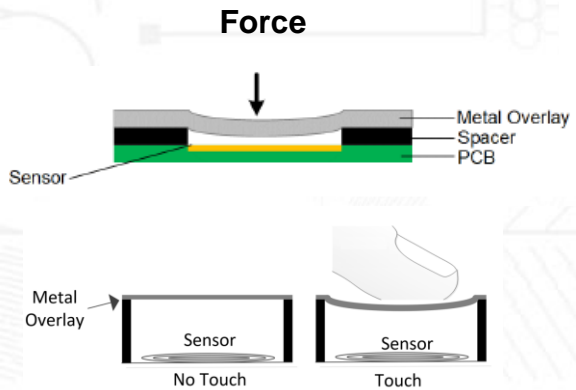
MagSense Rotary



MagSense Linear Transducer



MagSense Flow Meter



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# CapSense vs. MagSense Comparison

|               | CapSense Capacitive sensing  | MagSense Inductive sensing   |
|---------------|--|--|
| Advantages    | <ul style="list-style-type: none"> <li>• Provides hybrid sensing (mutual and self capacitive-sensing methods) to enable advanced features such as proximity sensing, hover and glove touch, liquid tolerance</li> <li>• Delivers multi-touch sensing capabilities (&gt; 2 touch)</li> <li>• Enables a low-cost system</li> <li>• Enables ease-of design into an application</li> </ul> | <ul style="list-style-type: none"> <li>• Provides robustness and reliability in harsh environment and surroundings</li> <li>• Enables a fully water-proof system</li> <li>• Enables underwater capabilities</li> <li>• Provides proximity sensing, glove touch</li> <li>• Provides reliable force sensing</li> </ul> |
| Disadvantages | <ul style="list-style-type: none"> <li>• Not fully water-proof, but is liquid tolerant (rejects water)</li> <li>• Easily affected by environment and surroundings</li> <li>• Tuning can be difficult</li> </ul>  | <ul style="list-style-type: none"> <li>• Complex HW design</li> <li>• Complex HW design results in lower yield</li> <li>• Tuning can be difficult</li> </ul>   |



# Hands-On



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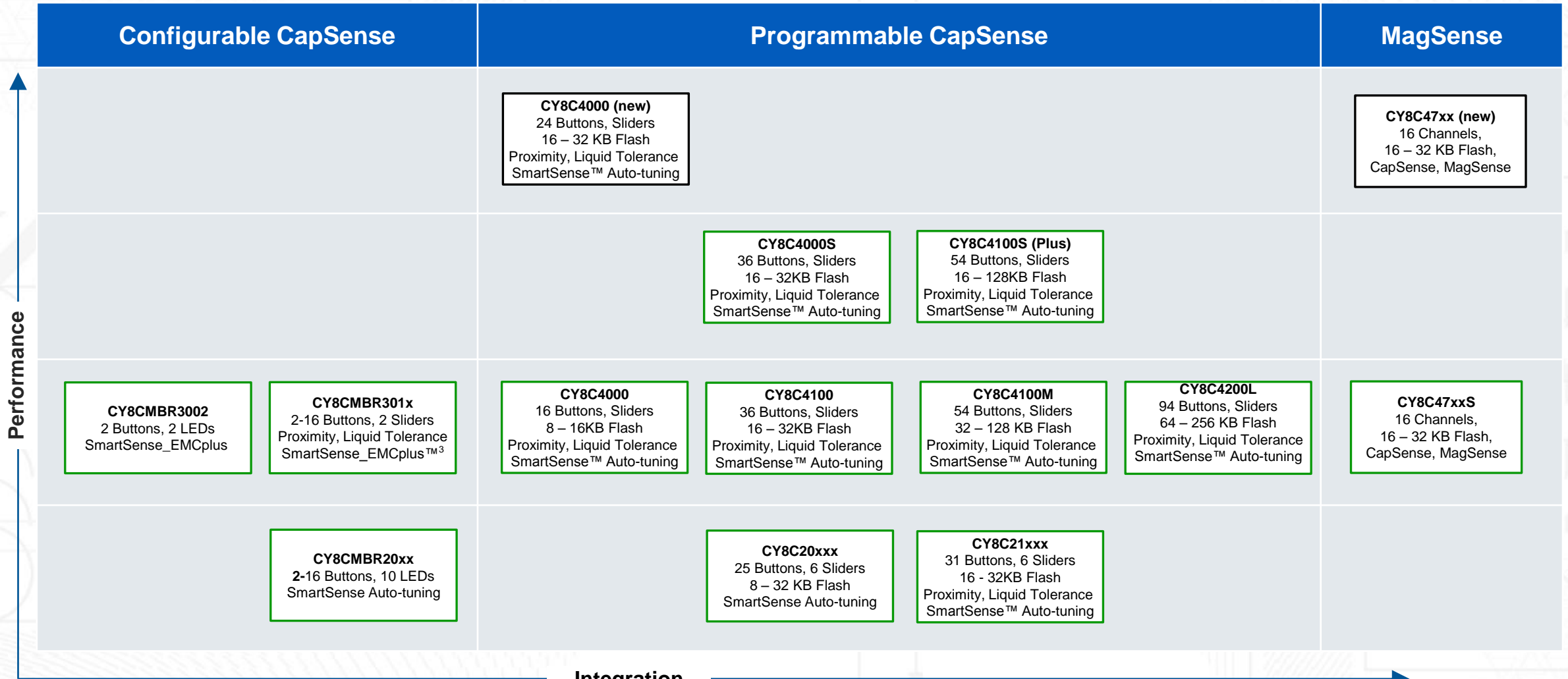


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# PSoC MCU Roadmap



# CapSense® and MagSense® Portfolio



<sup>1</sup> Standard products that are configured for target applications with a graphical user interface  
<sup>2</sup> Microcontroller-based products that can be freely programmed to implement additional functions  
<sup>3</sup> SmartSense Electromagnetic Compatible = SmartSense Auto-tuning + high noise immunity

Status Availability

|         |             |          |            |
|---------|-------------|----------|------------|
| Concept | Development | Sampling | Production |
|         |             |          |            |
|         |             | QYYY     | QYYY       |



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# PSoC 6 Arm Cortex-M4 MCUs for IoT

Ultra-Low-Power | Built-in Security | High-Performance

D+C



Features and Flash →

|   |                |  |  |                 |                 |
|---|----------------|--|--|-----------------|-----------------|
| <p><b>PSoC 64</b><br/>Secure MCU with Root-of-Trust</p> | <p>S: Q319</p> |  |  | <p>MP: Q420</p> | <p>MP: Q420</p> |
| <p><b>PSoC 63</b><br/>Integrated BLE</p>                |                |  |  |                 |                 |
| <p><b>PSoC 62</b><br/>Dual-Core M0+/M4</p>              | <p>S: Q319</p> |  |  | <p>MP: Q419</p> | <p>MP: Q419</p> |
| <p><b>PSoC 61</b><br/>Single-Core M4</p>                | <p>S: Q319</p> |  |  | <p>MP: Q419</p> | <p>MP: Q419</p> |

512KB Flash/256KB SRAM  
CAN-FD

512KB Flash/128KB SRAM  
Opamps, VDAC, UDBs

1MB Flash/288KB SRAM  
Opamps, VDAC, UDBs

1MB Flash/512KB SRAM

2MB Flash/1MB SRAM



# Getting Started



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# PSoC 4 Development Kits



## Make It Smarter

### Intelligent Analog Kits



[\\$25 PSoC 4 M-Series Pioneer Kit \(CY8CKIT-044\)](#)



[\\$10 PSoC 4100PS Prototyping Kit \(CY8CKIT-147\)](#)



## Make It Connected

### Bluetooth® Low Energy (BLE) Kits

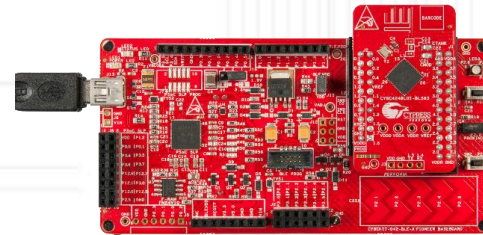


[CY8CKIT-143-A](#)



[CY8CKIT-141](#)

PSoC 4 BLE Modules\* with PCB or external antenna



[\\$49 PSoC 4 BLE Pioneer Kit \(CY8CKIT-042-BLE-A\)](#)

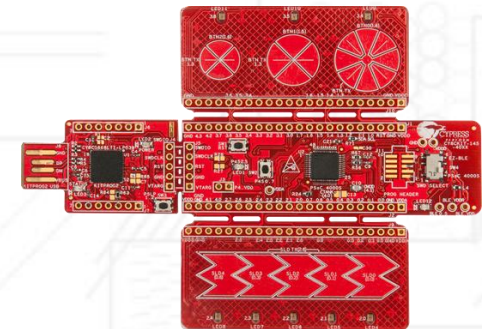


[\\$20 CySmart BLE USB Dongle \(CY5677\)](#)



## Make It Easy to Use

### HMI Kits for Capacitive Sensing



[\\$15 PSoC 4000S Prototyping Kit \(CY8CKIT-145-40xx\)](#)



[\\$20 CapSense Proximity Shield \(CY8CKIT-024\)](#)  
(Used with PSoC 4 Pioneer Kits)

\* Modules can be used independently or with PSoC Pioneer kits

PSoC 4 Kit Selector: [www.cypress.com/psoc4kits](http://www.cypress.com/psoc4kits)



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# Getting Started With PSoC<sup>®</sup> 4700

1. Download the [PSoC Creator IDE software](#)

2. Purchase a [PSoC 4700 kit](#)

3. Visit the [PSoC 4700 Product Page](#) and review datasheets, design guide and code examples

CE222867 - MAGSENSE WITH FEEDBACK LEDs



Configure 'IndSense'

Name: IndSense

Basic Advanced Built-in

| Type                             | Name       | Sensing mode            | Sensing element(s) |    |      |
|----------------------------------|------------|-------------------------|--------------------|----|------|
| <input checked="" type="radio"/> | Button0    | ISX (Inductive Sensing) | 1                  | Rx | 1 Lx |
| <input type="radio"/>            | Button1    | ISX (Inductive Sensing) | 1                  | Rx | 1 Lx |
| <input type="radio"/>            | Button2    | ISX (Inductive Sensing) | 1                  | Rx | 1 Lx |
| <input type="checkbox"/>         | Proximity0 | ISX (Inductive Sensing) | 1                  | Rx | 1 Lx |

Sensor resources  
ISX Electrodes: 8 Pins required: 10

Buttons: BTN3, BTN2, BTN1



[PSoC 4700 Inductive Sensing Evaluation Kit](#)

PSoC Creator IDE with Graphical Front Ends  
[www.cypress.com/Creator](http://www.cypress.com/Creator)

32-bit ARM<sup>®</sup> Cortex<sup>®</sup>-M0 PSoC<sup>®</sup> 4700 MCUs

DESIGN SLEEK INTERFACES THAT "SENSE ANYTHING" WITH PSoC<sup>®</sup> 4700 MCUs

Download PSoC Creator  
Product Selector Guide

Overview Getting Started Products Documentation Kits Software

The PSoC 4700 Family adds advanced sensing technologies to the 32-bit Arm Cortex-M0/M0+ PSoC 4 Portfolio of products to enable innovative next generation solutions. This family includes the PSoC 4700 S-Series that features an advanced inductive sensing technology for highly reliable human-machine interfaces, fully waterproof interfaces and other new, innovative solutions.

**PSoC 4700S Features**

- 32-bit MCU Subsystem
- 48 MHz Arm<sup>®</sup> Cortex<sup>®</sup>-M0+ CPU
- Up to 32KB Flash and 4KB SRAM

**Programmable Analog Blocks**

- One 10-bit, 16.8-keeps Single-Slope ADC
- Two low-power comparators (CMP)
- Two 7-bit DACs configurable as a single 8-bit DAC
- One MagSense<sup>™</sup> block that enables sensing of metal objects
- One CapSense<sup>®</sup> block that supports low-power operation with self- and manual-capacitance sensing

**Programmable Digital Blocks**

- Five configurable 16-bit Timer, Counter, PWM (TCPWM) blocks
- Two Serial Communication Blocks (SCBs) that are configurable as I2C, SPI or UART

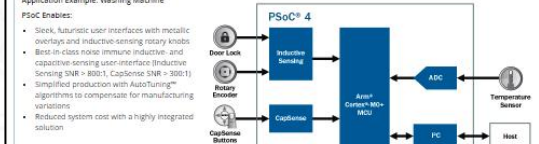
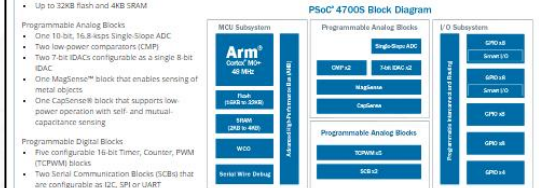
**Packages**

- 25-ball WLCSP, 24-pin QFN, 48-pin TQFP
- Up to 36 GPIOs, including 16 Smart I/Os

**Application Example: Washing Machine**

**PSoC Enables:**

- Seek, tactile user interfaces with metallic overlays and inductive sensing rotary knobs
- Best-in-class noise immune inductive- and capacitive sensing user interface (Inductive Sensing SNR > 800:1, Capacitive SNR > 300:1)
- Simplified production with AutoTuning<sup>™</sup> algorithms to compensate for manufacturing variations
- Reduced system cost with a highly integrated solution

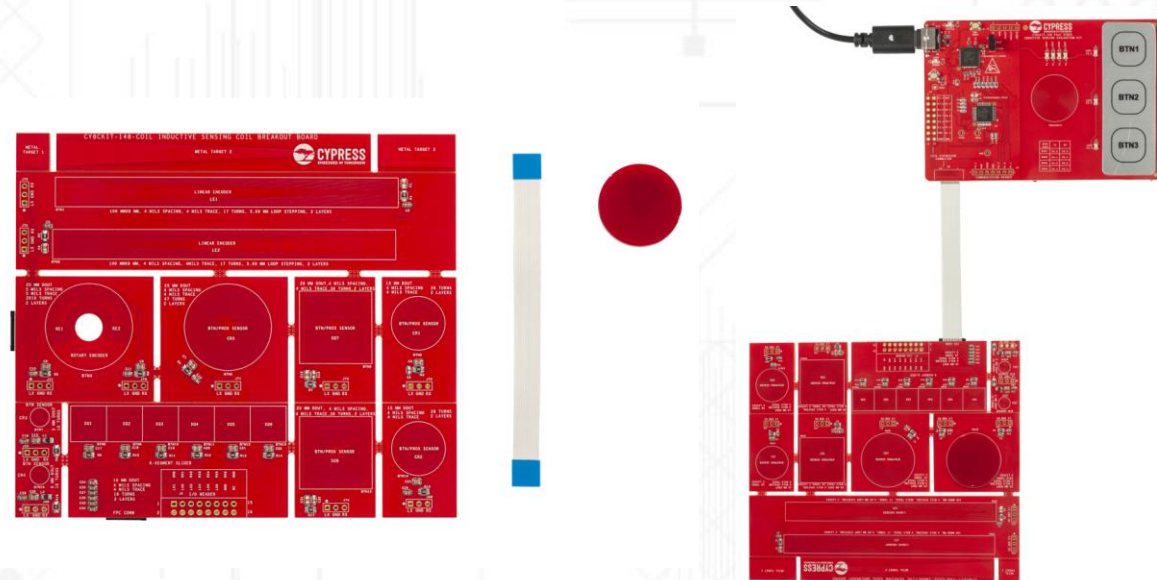




# CY8CKIT-148-COIL Inductive Sensing Breakout Board

- CY8CKIT-148-COIL Inductive Sensing Breakout Board features the following:
  - Snap-able metal targets
    - 1x Linear Metal Target
    - 2x rectangular metal targets
    - 1x Rotary Encoder target
  - Snap-able coils
    - 2x Linear Encoders
    - 1x Rotary Encoder
    - 1x 6-Segment Button Slider
    - 2x 20mm Square Coils
    - 1x 25mm Circular Coil
    - 2x 15mm Circular Coils
    - 2x 5mm Circular Coils

CY8CKIT-148-COIL Inductive Sensing Breakout Board image





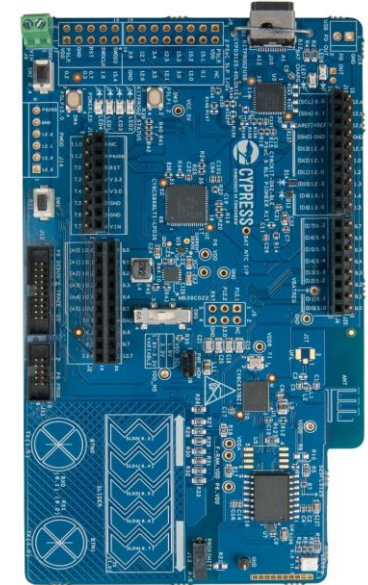
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- Purchase the [PSoC 6 BLE Pioneer Kit](#), [PSoC 6 WiFi-BT Pioneer Kit](#), or [PSoC 6 Wi-Fi BT Prototyping Kit](#)
- Join the [PSoC 6 Community](#) to interact with us
- **PSoC 6 BLE Pioneer Kit provides:**
  - Capacitive-sensing CapSense slider and buttons and 512Mb QSPI NOR flash memory
  - Compatible form factor with Arduino® shields and Digilent® Pmod™ daughter cards
- **PSoC 6 WiFi-BT Pioneer Kit provides:**
  - Capacitive-sensing CapSense slider and buttons and 512Mb QSPI NOR Flash memory
  - Compatible form factor with Arduino shields and Digilent Pmod daughter cards
  - Murata LBEE5KL1DX-TEMP Module (CYW4343W) that provides IEEE 802.11a/b/g/n WLAN + Bluetooth
- **PSoC 6 Wi-Fi BT Prototyping Kit provides:**
  - Snappable peripherals: Capacitive-sensing CapSense slider and buttons, Digilent Pmod interface, 512Mb QSPI NOR flash, uSD card, PDM-PCM microphone, thermistor
  - Bread-board compatible form-factor
  - Murata LBEE5KL1DX-TEMP Module (CYW4343W) that provides IEEE 802.11a/b/g/n WLAN + Bluetooth

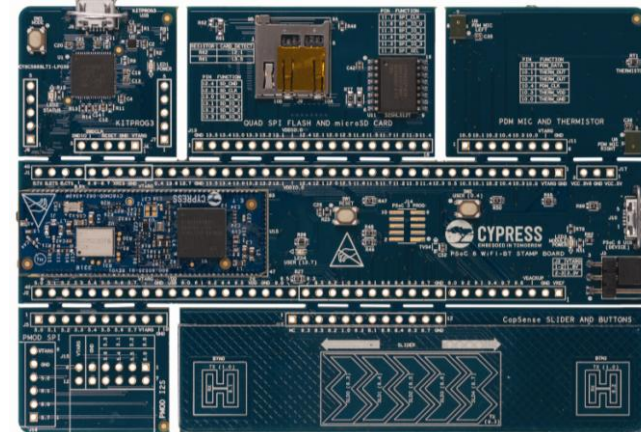
\$99 PSoC 6 WiFi-BT Pioneer Kit  
(CY8CKIT-062-WiFi-BT)



\$75 PSoC 6 BLE Pioneer Kit  
(CY8CKIT-062-BLE)



\$30 PSoC 6 Wi-Fi BT Prototyping Kit  
(CY8CPROTO-062-4343W)



# Getting Started

1. Download the [PSoC Creator IDE](#)
2. Purchase any of Cypress CapSense/MagSense Eval Kits:

**PSoC 4700 MCU Inductive Sensing Eval Kit ([CY8CKIT-148](#))**

**PSoC 4 MCU Kits w/ CapSense:**

- PSoC 4 BLE Pioneer Kit ([CY8CKIT-042-BLE-A](#))
- PSoC 4000S Prototyping Kit ([CY8CKIT-145-40XX](#))
- PSoC 4 M-Series (Intelligent Analog) Pioneer Kit ([CY8CKIT-044](#))
- CapSense Liquid Level Sensing Shield (for use w/ PSoC 4 Kits ([CY8CKIT-022](#)))
- CapSense Proximity Shield (for use w/ PSoC 4 Kits ([CY8CKIT-024](#)))

**PSoC 6 MCU Kits w/ CapSense:**

- PSoC 6 BLE Pioneer Kit ([CY8CKIT-062-BLE](#))
- PSoC 6 WiFi-BT Pioneer Kit ([CY8CKIT-062-WIFI-BT](#))
- PSoC 6 WiFi-BT Prototyping Kit ([CY8CPROTO-062-4343W](#))

3. Join the [Cypress Developer Community \(CDC\)](#)
4. Start your design with any of the kits above and resources to the right. Interact with our engineers on the CDC if you need help!

# References and Links

## Product Pages

- [PSoC 4 MCU Family Page](#)
- [PSoC 6 MCU Family Page](#)
- [Cypress Sensing Technologies Page](#)
- [PSoC MCU Roadmap](#)
- [PSoC MCU Development Kits Selector](#)

## Cypress Developer Community (CDC)

- [PSoC 4 Community](#)
- [PSoC 6 Community](#)
- [Cypress Sensing Technologies Community](#)

## App Notes/Datasheets/Technical Docs

- [PSoC 6 MCU Datasheets](#)
- [PSoC 4 MCU Datasheets](#)
- [PSoC 4 and PSoC 6 MCU CapSense Design Guide App Note](#)
- [Getting Started With CapSense App Note](#)
- [PSoC 4 Low-Power CapSense Design Guide](#)
- [PSoC 4 Capacitive Liquid Level Sensing App Note](#)
- [Proximity Sensing With CapSense App Note](#)
- [Inductive Sensing Design Guide](#)
- [All Cypress CapSense/MagSense Resources](#)





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